

#### **Description**

The BSC0901NS uses advanced trench technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

### **General Features**

V<sub>DS</sub> = 30V I<sub>D</sub> =150A

 $R_{DS(ON)} < 2.4 \text{m}\Omega \text{ V}_{GS} = 10 \text{V}$ 

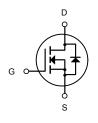
### **Application**

Battery protection

Load switch

Uninterruptible power supply

DFN5X6-8L



N-Channel MOSFET

#### **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
BSC0901NS	DFN5X6-8L	HXY MOSFET	5000

### Absolute Maximum Ratings (Tc=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units		
Vos	Drain-Source Voltage	30			
Vgs	Gate-Source Voltage	V			
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	150	А		
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	80	Α		
Іом	Pulsed Drain Current <sup>2</sup>	160	А		
EAS	Single Pulse Avalanche Energy <sup>3</sup>	180	mJ		
las	Avalanche Current	60	Α		
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	187	W		
Тѕтс	Storage Temperature Range	-55 to 150	°C		
TJ	Operating Junction Temperature Range	-55 to 150	°C		
Reja	Thermal Resistance Junction-Ambient <sup>1</sup>	62	°C/W		
Rejc	Reuc Thermal Resistance Junction-Case <sup>1</sup>		°C/W		



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.014		V/°C	
Descour	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =30A		2	2.4	mΩ	
R <sub>DS(ON)</sub>	Static Diain-Source On-Resistance	V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		2.5	3.2		
$V_{GS(th)}$	Gate Threshold Voltage	\\ <del>-</del> \\  - <del>-</del> 250\	1.2		2.5	٧	
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250uA$		-4		mV/°C	
1	Drain Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1		
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA	
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA	
gfs	Forward Transconductance	vard Transconductance V <sub>DS</sub> =5V , I <sub>D</sub> =30A		50		S	
Rg	Gate Resistance	ance V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7		Ω	
$Q_g$	Total Gate Charge (4.5V)			56.9			
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =10V , I <sub>D</sub> =15A		13.8		nC	
$Q_{gd}$	Gate-Drain Charge			23.5		1	
T <sub>d(on)</sub>	Turn-On Delay Time			20.1			
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =3.3 $\Omega$ ,		6.3			
$T_{d(off)}$	Turn-Off Delay Time	I <sub>D</sub> =1A		124.6		ns	
Tf	Fall Time			15.8			
Ciss	Input Capacitance			4345			
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		340		pF	
Crss	Reverse Transfer Capacitance			225			

#### **Diode Characteristics**

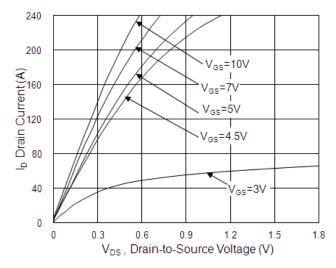
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			150	Α
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{GS}$ =0V , $I_{S}$ =1A , $T_{J}$ =25 $^{\circ}$ C			1.2	V

#### Note

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\,\leq\,300\text{us}$  , duty cycle  $\,\leq\,2\%$
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =60A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.
- 6. Package limitation current is 85A.



# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

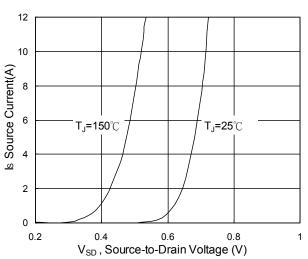


Fig.3 Forward Characteristics of Reverse

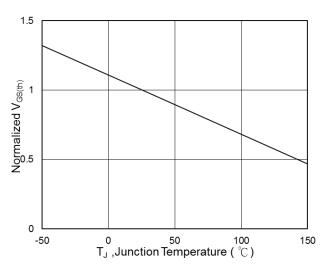


Fig.5 Normalized  $V_{\text{GS(th)}}$  v.s  $T_{\text{J}}$ 

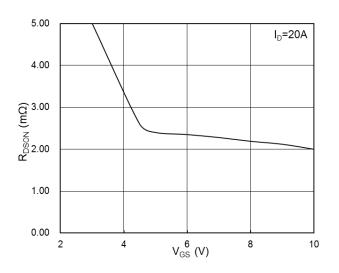


Fig.2 On-Resistance v.s Gate-Source

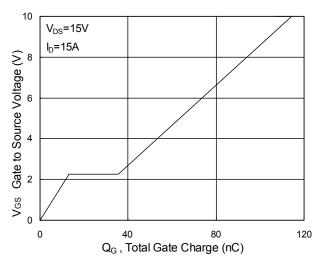


Fig.4 Gate-Charge Characteristics

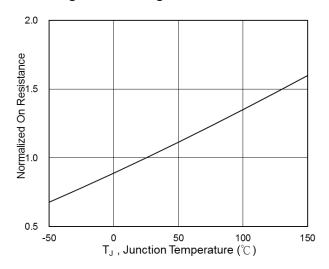
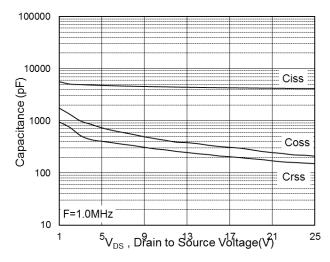


Fig.6 Normalized R<sub>DSON</sub> v.s T<sub>J</sub>



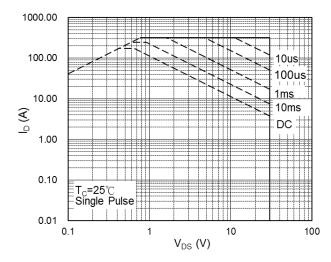


Fig.7 Capacitance

Fig.8 Safe Operating Area

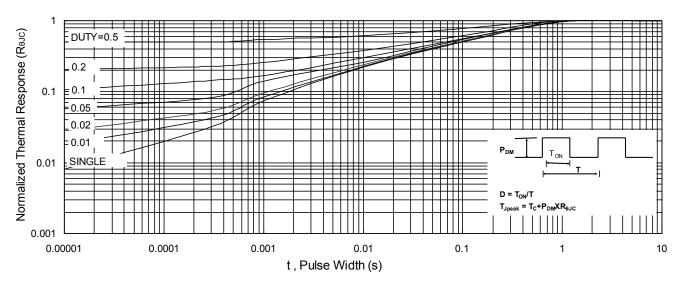
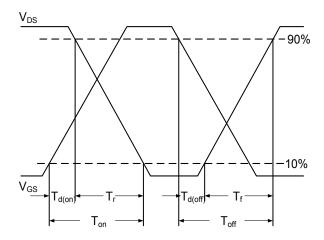


Fig.9 Normalized Maximum Transient Thermal Impedance





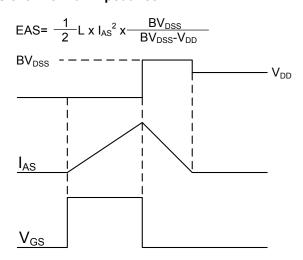
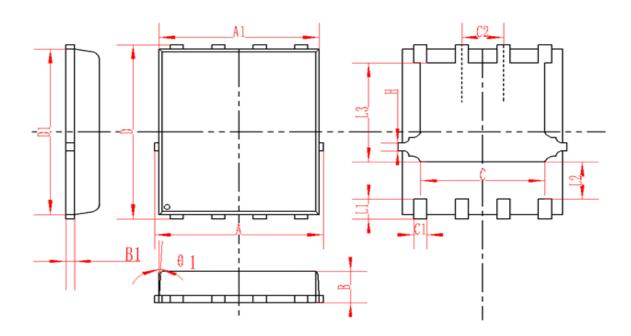


Fig.11 Unclamped Inductive Switching Waveform



# **DFN5X6-8L Package Information**



SYMBOL		MM			INCH			
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX		
А	4.95	5	5.05	0.195	0.197	0.199		
A1	4.82	4.9	4.98	0.190	0.193	0.196		
D	5.98	6	6.02	0.235	0.236	0.237		
D1	5.67	5.75	5.83	0.223	0.226	0.230		
В	0.9	0.95	1	0.035	0.037	0.039		
B1	0.254REF			0.010REF				
С	3.95	4	4.05	0.156	0.157	0.159		
C1	0.35	0.4	0.45	0.014	0.016	0.018		
C2	1.27TYP			0.5TYP				
θ1	8°	10°	12°	8°	10°	12°		
L1	0.63	0.64	0.65	0.025	0.025	0.026		
L2	1.2	1.3	1.4	0.047	0.051	0.055		
L3	3.415	3.42	3.425	0.134	0.135	0.135		
Н	0.24	0.25	0.26	0.009	0.010	0.010		



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